

SMART PRINT UV

A MASKLESS LITHOGRAPHY SYSTEM

Microfluidics

Microelectronics

Optoelectronics

Spintronics

2D Materials

Biotechnologies



SMART PRINT UV is a maskless lithography equipment, based on a Digital Micromirror Device projection technology (DMD), compatible with a wide range of resists and substrates.

SMART PRINT UV can produce any 2D shapes at micron resolution without the need for a hard-mask.



KEY FEATURES

- > Writing resolution down to 1.5 µm
- Adjustable writing field and resolution with exchangeable objectives
- > Compatible with CAD files or bitmap images
- > Compatible with i, h and g-line photoresists
- > Compatible with a wide range of substrates (silicon, glass, metal, plastic,...)
- Compatible with any sample size up to 5" square masks
- > Camera feedback for alignment steps

KEY BENEFITS

- > Time and money saving due to the absence of a hard-mask
- > Intuitive alignment method with direct overlay of the design on the sample
- > Table-top with small foot print
- Technology well suited for microfluidics,
 2D-materials, optoelectronics, or any other
 2D microfabrication application

100 um



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> MICROFABRICATION SYSTEM

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Light source	Exposure: 385 nm ; Alignment: 590 nm		
Minimum feature size	1.5 µm		
Alignment accuracy (for 1 cm² printed area)	2 µm	1 µm	
Maximum exposure area	70 x 70 mm²	110 x 110 mm²	
Substrate size	Up to 4"	Up to 5"x5"	
Writing speed	77 mm²/min	220 mm²/min	
System dimensions	W x D x H = 52 x 52 x 69 cm ³		

Standard

Advanced

> SOFTWARE PACKAGE

Computer	With Windows 11 Pro, 24" full HD screen	
Phaos software	Machine control, step-and-repeat, automatic dose test, stitching, alignment Conversion of standard CAD formats (gdsii, dxf, cif, oas) to machine format. CAD software included	

> OPTIONS AND ACCESSORIES

Multiple-sample holder (glass-slide, 4" wafer,...) Objectives (see below)

Objectives	1X	2.5X	5X	10X
Writing fields (mm)	10.56 x 5.9	4.2 x 2.4	2.1 x 1.2	1.06 x 0.59
Smallest features (µm)	15	6	3	1.5

Specifications depend on individual process conditions and may vary according to equipment configuration Writing speed depends on exposure area and objective. Design and specifications are subject to change without prior notice.



